**BUFFER ISSUE RESOLUTION DOCUMENT (BIRD)**

**BIRD NUMBER: *Draft 2, April 23, 2014***

**ISSUE TITLE:** *Package Modeling Using IBIS-ISS*

**REQUESTOR:**  *Walter Katz, Signal Integrity Software, Inc.*

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**STATEMENT OF THE ISSUE:**

This BIRD enhances IBIS Packaging models to support Broadband and Coupled package and on-die interconnect using IBIS-ISS and Touchstone models (ISS Models).

**ANALYSIS PATH/DATA THAT LED TO SPECIFICATION:**

Definitions:

ISS

ISS package and on-die modeling makes several assumptions:

1. ISS Models can either be IBIS-ISS subckts or Touchstone Files
2. If two points are “Connected” then there is either a low resistance DC electrical path between the two points, or a small insertion loss at Nyquist frequency between the two points.
3. For each I/O Pin, there is a Die Pad and Buffer I/O that are “Connected”.
4. For each POWER or GND Signal\_name, all pins, die pads and buffer supply terminals that use that Signal\_name are “Connected”
5. The Ports (or Terminals) of ISS Models are Pins, Die Pads, Buffer I/O or Buffer supply terminals.
6. An ISS Model may represent a single connection between Pins and Buffers, Pins and Die Pads, or Die Pads and Buffers. An ISS Model may also represent multiple connections between Pins and Buffers, Pins and Die Pads, or Die Pads and Buffers.

**ANY OTHER BACKGROUND INFORMATION:**

{*These documents will be archived, so use this section to add any detail that is not part of the section above or the changed text itself , but should not be lost.}*

*Keyword:* **[ISS Model Data]**

*Required:* Sometimes.

*Description:* The begins a section in [Define Package Model] that contains the interfaces to IBIS-ISS subckts and Touchstone Files

*Sub-Params:* Lots, TBD

*Usage Rules:* [Define Package Model]

TBD

*Other Notes:*

Following on page 137/138 needs to change.

Either the [Number Of Sections] or the [Model Data]/[End Model Data] keywords are required. Note that [Number of Sections] and the [Model Data]/[End Model Data] keywords are mutually exclusive.

To

Either the [Number Of Sections], [ISS Model Data] or the [Model Data]/[End Model Data] keywords are required. Note that [Number of Sections], [ISS Model Data] and the [Model Data]/[End Model Data] keywords are mutually exclusive.

There a number of Editorial Changes with this new [Define Package Model] keyword.

I see no need for [Number Of Pins] or [Pin Numbers],

*Example:*

[ISS Model Data]

*Keyword:* **[End ISS Model Data]**

*Required:* Yes, if there is a |

*Description:* Indicates the end of the formatted ISS model data.

*Other Notes:* In between the [ISS Model Data] and [End ISS Model Data] keywords is the package model data itself. The data is any number of interfaces to either IBIS-ISS models or Touchstone files.

*Example:*

[End ISS Model Data]

*Keyword:* **[Begin ISS Model] <ISS Model Name>**

*Required:* Yes.

*Description:* The begins a section in [ISS Model Data] that contains the data required to interface to IBIS-ISS subckts or Touchstone Files

*Sub-Params:* Lots, TBD

*Usage Rules:* [Begin ISS Model] <ISS Model Name>

TBD

*Other Notes:*

<ISS Model Name> is not used in simulation, it is just a name to describe this model interface. Two [Begin ISS Model] keywords may not have the same <ISS Model Name>

*Example:*

[Begin ISS Model] DQ1

*Keyword:* **[End ISS Model]**

*Required:* Yes.

*Description:* Indicates the end of the formatted ISS model interface.

*Other Notes:* In between the [Begin ISS Model] and [End ISS Model] keywords is the interface to either IBIS-ISS models or Touchstone files.

*Example:*

[End ISS Model]

*Subparameter:* **[Language] IBIS-ISS|Touchstone**

*Required:* Yes.

*Description:* Indicates if the model is an IBIS-ISS subckt or a Touchstone file.

*Other Notes:*

*Example:*

[Language] IBIS-ISS

*Subparameter:* **[File] <format> <file name> {<file name> <file name>}**

*Required:* Yes.

*Description:* Defines the file(s) containing the model.

*Other Notes: The Files must be either IBIS-ISS files or Touchstone files.*

<format> need to points to a <format> section describing Value, DelayCorner, …

*Example:*

File Value my\_file.iss

*Subparameter:* **[Subckt] <format> <subckt name> {< subckt name> < subckt name>}**

*Required:* Yes if Language IBIS-ISS.

*Description:* Defines the subckt(s) in the [File]

*Other Notes:*

*Example:*

Subckt Value my\_subckt

*Subparameter:* **[Parameter] <name> <format> <param value> {<param value > <param value >}**

*Required:* Sometimes if Language IBIS-ISS.

*Description:* Defines the parameters that are to be passed into an instance of the IBIS-ISS subckt. <name> is the name of the parameter. <format> is described below. Depending on the <format> used there will be one or more than one <param value>. String parameters shall be enclosed in “’”.

*Other Notes:* One must watch there m and M’s when entering parameter value scale factors. Please consider the following table of parameter values and how IBIS and IBIS-ISS evaluate them:

Param IBIS IBIS-ISS

1m 1e-3 1e-3

1M 1e6 1e-3

1meg 1e-3 1e6

1Meg 1e6 1e6

Parameter values shall assume the IBIS interpretation. It is recommended that when generating these parameter records, that model makers use the 1m and 1Meg constructs to avoid any possible confusion by an EDA tool or User.

Parameters are not passed into a Touchstone file; however, there are two optional reserved parameters that are used in conjunction with Language Touchstone. They are FBASE and FMAX. They must be of Format Value. See the IBIS-ISS manual to understand how FBASE and FMAX should be used in conjunction with Touchstone files.

<format> may be

Value <value>

DelayCorner <Typ> <Fast> <Slow>

XtalkCorner <Typ> <Min Crosstalk> <Max Crosstalk>

DelayXtalkCorner <nine corners need to be listed>

Gaussian <Mean> <Gaussian>

Integer Range <Typ> <Min> <Max>

Real Range <Typ> <Min> <Max>

PDF <probability> <value> <probability> <value> <probability> <value> …

List <typical value> <value> <value> <value> <value> <value> …

*Examples:*

Parameter Length Value 11.

Parameter Tstonefile Value ‘abc.s2p’

*Subparameter:* **[Unused Port Termination] <resistance>**

*Required:*  No

*Description:* Defines the termination that is to be applied to the Ports of a subckt or Touchstone file that are not being used.

*Other Notes:* If this subparameter is defined the EDA should connect the unused Ports to GND through a **<resistance>** ohm resistor.

If this parameter is not defined and if Language is IBIS-ISS, then the EDA tool should connect the unused Ports to GND through a 1Meg ohm resistor. If Language is Touchstone, then the EDA tool should connect the unused Ports to GND through a resistor with the Touchstone File reference resistance of the Port.

*Example:*

[Unused Port Termination] 50

*Subparameter:*  **[Port] <Field 1> <Field 2> <Field 3> <Field 4> (<Field 5> <Field 6>)**

*Required:* Port is required.

*Description:* Each Port record contains information on a port (or terminal) of an IBIS-ISS subckt (or Touchstone file).

<Field 1> Port Number. This must be an integer number greater or equal to 1 and less than or equal to the number of ports (aka terminals) of the IBIS-ISS subckt (or Toucshtone file). Two [Port] records may not have the same Port Number. If a Port Number does not exist in any of the [Port] records then the port is unused, and should be terminated according to the [Unused Port Termination Rules].

<Field 2> Shall be either Pin Pad or Buffer. This describes if the Port is at a Pin, Die Pad, or at the Buffer.

<Field 3> Shall be either Pin\_name, Signal\_name, Model\_name or Default.

<Field 4> If <Field 3> is Pin\_name, Signal\_name or Model\_name then <Field 4> shall be either a legal Pin\_name, Signal\_name or Model\_name respectively. If <Field 3> is Default then <Field 4> shall be NA.

<Field 5> If the connection on this port is to a Buffer signal terminal then <Field 3> is Model\_name or Default <Field 5> shall be either Diff\_pos, Diff\_neg or SE, otherwise it shall be NA. If the connection on this port is to a Buffer supply terminal, then <Field 5> shall be either Pullup\_Reference, Pulldown\_Reference , Power\_Clamp\_Reference , Ground\_Clamp\_Reference or External\_Reference.

<Field 6> Is the channel number. A channel is either a single connection or two connections that form a differential pair. If there is only one channel in the model then <Field 6> may be NA.

<Field 7> Shall contain Aggressor or NA. If NA, then this channel accurately represents that channel through path and crosstalk from all of the other channels. If Aggressor than the channel only accurately represents the crosstalk to all of the NA (Victim) channels.

*Other Notes:*

Fields at then end of a Port record that are NA are optional

If <Field 2> is Buffer, and the port connects to ths

*Example:*

Port 1 Pin    Pin\_name M8 NA NA NA

Port 1 Pin    Pin\_name M8

Port 1 Pad Pin\_name M8

Port 1 Buffer Pin\_name M8

Port 1 Buffer Pin\_name M8 Pullup\_Reference

Port 1 Pin Model\_name DQ

Port 1 Pin Model\_name DQS Diff\_pos

Port 1 Pin Default NA SE

Port 1 Pin Model name DQ SE

Port 1 Buffer Pin\_name M8 NA 2

Port 1 Buffer Pin\_name M8 NA 3 Aggressor

Port 1 Buffer Signal\_name VDDQ

*Keyword:* **[Die Supply Pads]**

*Required:* Sometimes.

*Description:* This begins a section in [Component] that contains one line of data for die pads supply nodes. IBIS assumes that for I/O pins (pins that have a Model\_name that is not POWER, GND or NC), there is a one to one correspondence between a Pin, Die Pad and Buffer I/O. There are no such assumptions for POWER and GND pins. A POWER or GND Signal\_name may have a different number of Pin nodes, die pad nodes and buffer nodes. If the model maker chooses to make separate package and on-die power distribution networks (PDN), then he must supply a list of nodes (and their associated Signal\_name) that can be used to mate the package and on-die PDN models.

*Sub-Params:* ?

*Usage Rules:*  TBD

*Other Notes:* The data in this section consists of a list of die pad node names and their corresponding Signal\_names that can be used to mate package and on-die PDN networks.

*Example:*

[Die Supply Pads]

VDD1 VDD

VDD2 VDD

VDD3 VDD

VSS1 VSS

VSS2 VSS

*Keyword:* **[End Die Supply Pads]**

*Required:* Yes.

*Description:* Indicates the end of the [Die Supply Pads] data.

*Other Notes:*

*Example:*

[End Die Supply Pads]

**Examples**

[Define Package Model]

[ISS Model Data]

[Begin ISS Model] IOA3

Language Touchstone

File Value ioA3.s2p

Port 1 Pin Pin\_name A3

Port 2 Buffer Pin\_name A3

[End ISS Model]

[Begin ISS Model] IOA7

| This model uses I/O pin A7

Language Touchstone

File Value ioA7.s2p

Ports Pin.A7 Buf.A7

[End ISS Model]

[Begin ISS Model] IOB3C3

Language Touchstone

File Value ioB3C3.s4p

Port 1 Pin Pin\_name B3

Port 2 Buffer Pin\_name B3

Port 3 Pin Pin\_name C3

Port 4 Buffer Pin\_name C3

[End ISS Model]

[Begin ISS Model] IOA3

Language IBIS\_ISS

File Value io.iss

Subckt io

Parameter Length Value 10. | 10mm

Port 1 Pin Pin\_name A3

Port 2 Buffer Pin\_name A3

[End ISS Model]

[Begin ISS Model] DQS

Language Touchstone

File Value DQS.s4p

Port 1 Pin Model\_name DQS Diff\_pos

Port 2 Buffer Model\_name DQS Diff\_pos

Port 3 Pin Model\_name DQS Diff\_neg

Port 4 Buffer Model\_name DQS Diff\_neg

[End ISS Model]

[Begin ISS Model] VDDQ

Language IBIS\_ISS

File Value vddq.iss

Subckt vddq

Port 1 Pin Signal\_name VDDQ

Port 2 Buffer Signal\_name VDDQ

[End ISS Model]

[Begin ISS Model] VDDQ\_A3

Language IBIS\_ISS

File Value vddq\_a3.iss

Subckt vddq\_A3

Port 1 Pin Signal\_name VDDQ

Port 2 Buffer Pin\_name A3 Pullup\_Reference

[End ISS Model]

[Begin ISS Model] IOA3

Language Touchstone

File Value ioA3.s2p

Port 1 Pin Pin\_name A3

Port 2 Buffer Pin\_name A3

Port 3 Pin Model\_name DQ NA 1 Aggressor

Port 4 Buffer Model\_name DQ NA 1 Aggressor

Port 5 Pin Model\_name DQ NA 2 Aggressor

Port 6 Buffer Model\_name DQ NA 2 Aggressor

Port 7 Pin Model\_name DQS Diff\_pos 3 Aggressor

Port 8 Buffer Model\_name DQS Diff\_pos 3 Aggressor

Port 9 Pin Model\_name DQS Diff\_neg 3 Aggressor

Port 10 Buffer Model\_name DQS Diff\_neg 3 Aggressor

[End ISS Model]

[End ISS Model Data]

[End Package Model]